

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
60V	6mΩ@10V	70A

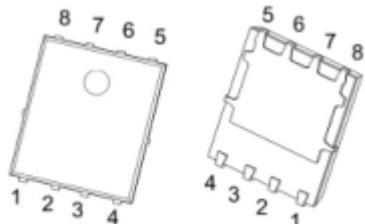
Feature

- Fast Switching
- Low Gate Charge and Rdson
- 100% Single Pulse avalanche energy Test

Applications

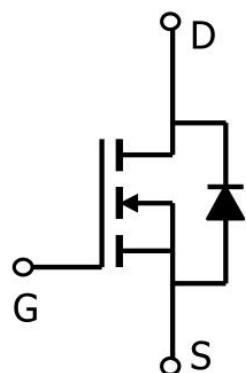
- Power switching application
- DC-DC Converter
- Power Management

Package



PDFNWB5x6-8L

Circuit diagram

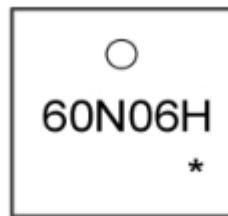




ZL MOSFET

ZL60N06HD

Marking



60N06H : Product code
* : Month code

Absolute maximum ratings

($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current($T_c=25^\circ\text{C}$)	I_D	70	A
Pulse Drain Current Tested	I_{DM}	280	A
Power dissipation($T_c=25^\circ\text{C}$)	P_D	97	W
Single Pulse Avalanche Energy ¹	E_{AS}	169	mJ
Thermal Resistance-Junction to Case	$R_{\theta JC}$	1.29	$^\circ\text{C}/\text{W}$
Storage Temperature Range	T_{STG}, T_J	-55~ +150	$^\circ\text{C}$

Electrical characteristics

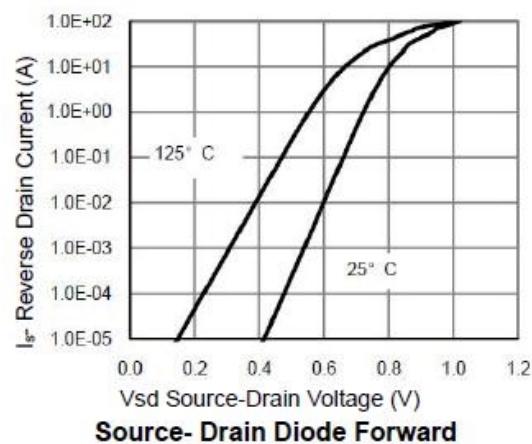
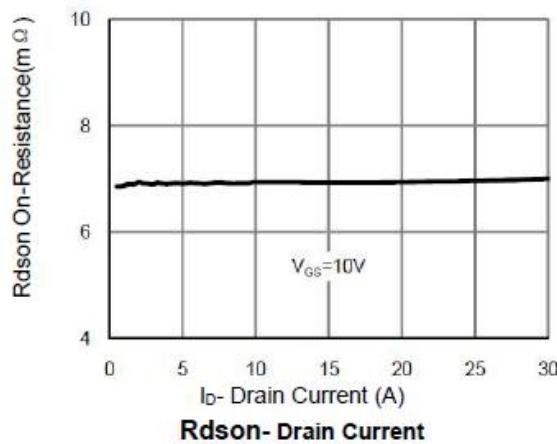
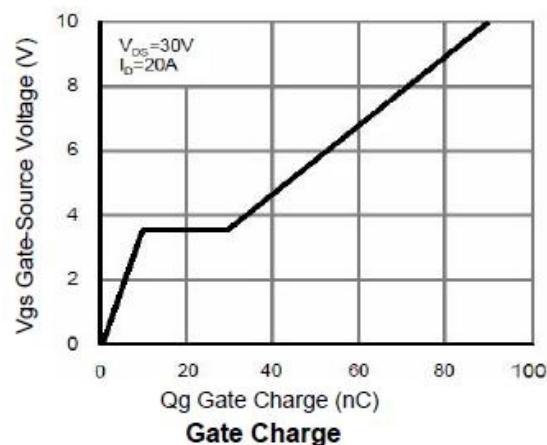
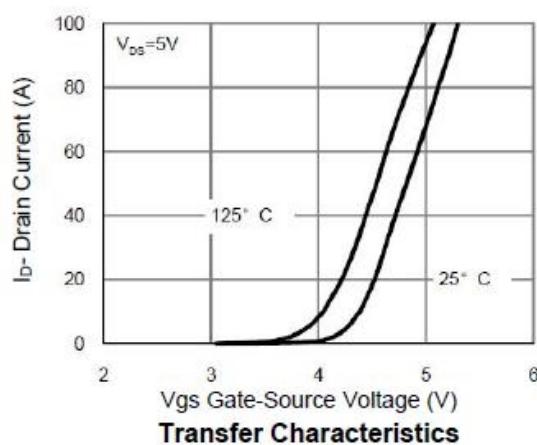
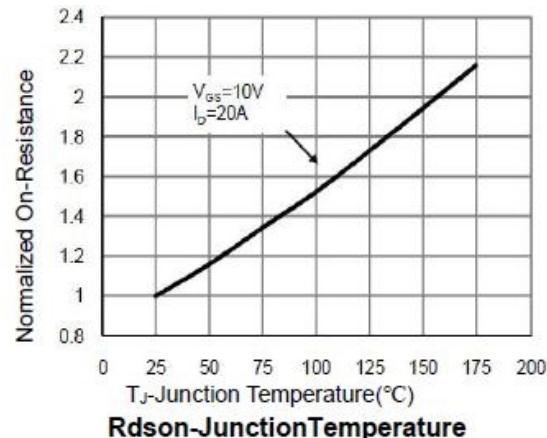
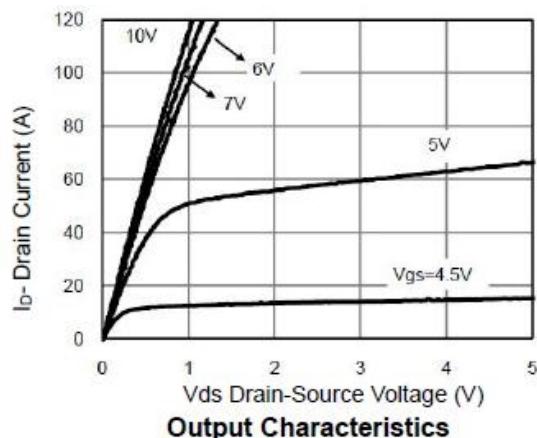
($T_A=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	$\text{BV}_{(\text{BR})\text{DSS}}$	$V_{GS} = 0\text{V}, I_D = 250\mu\text{A}$	60			V
Drain Cut-Off Current	I_{DSS}	$V_{DS} = 48\text{V}, V_{GS} = 0\text{V}$			1	μA
Gate-source leakage current	I_{GSS}	$V_{GS} = \pm 20\text{V}, V_{DS} = 0\text{V}$			± 0.1	μA
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	2.0	3.0	4.0	V
Drain-Source On-State Resistance	$R_{DS(\text{on})}$	$V_{GS} = 10\text{V}, I_D = 20\text{A}$		6	7.5	$\text{m}\Omega$
Dynamic Characteristics Reverse						
Input Capacitance	C_{iss}	$V_{DS} = 30\text{V}, V_{GS} = 0\text{V}, f = 1.0\text{MHz}$		4010		pF
Output Capacitance	C_{oss}			293		
Reverse Transfer Capacitance	C_{rss}			215		
Switching Characteristics						
Total gate charge	Q_g	$V_{DS} = 30\text{V}, V_{GS} = 10\text{V}, I_D = 20\text{A}$		91		pF
Gate-source charge	Q_{gs}			9		
Gate-drain charge	Q_{gd}			18.5		
Turn-On Delay Time	$T_{d(on)}$	$V_{GS} = 10\text{V}, V_{DS} = 30\text{V}, I_D = 20\text{A}, R_G = 3\Omega$		8.5		nS
Rise Time	T_r			7		
Turn-Off Delay Time	$T_{d(off)}$			41		
Fall Time	T_f			14		
Drain-Source Body Diode Characteristics						
Source-Drain Diode Forward Voltage	V_{SD}	$V_{GS} = 0\text{V}, I_S = 1\text{A}$			1.2	V

Note :

1. E_{AS} is tested at starting $T_j = 25^\circ\text{C}$, $V_{DD} = 30\text{V}, V_{GS} = 10\text{V}, L = 0.5\text{mH}, R_G = 25\text{m}\Omega$;

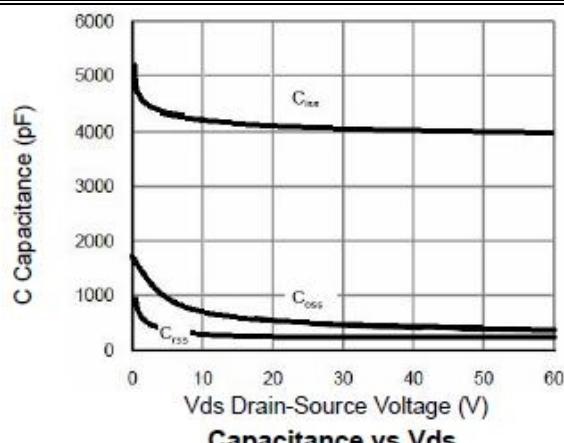
Typical Characteristics



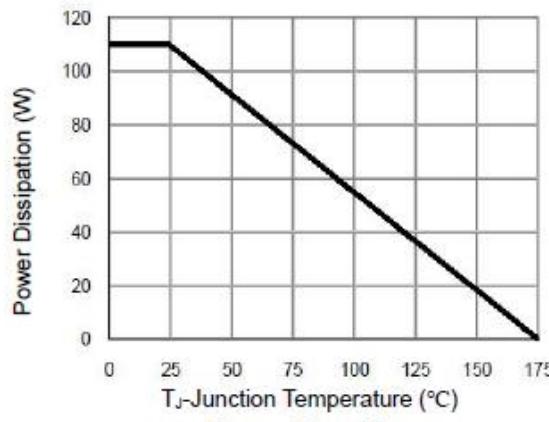


ZL MOSFET

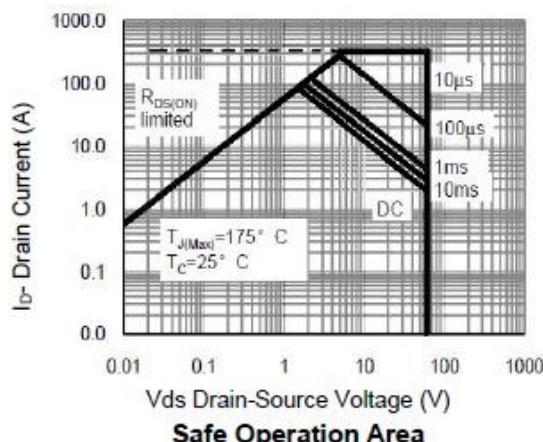
ZL60N06HD



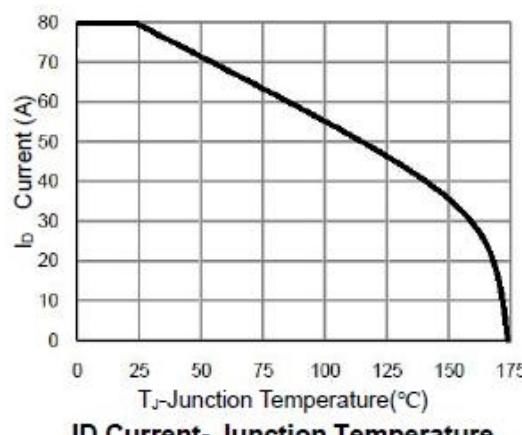
Capacitance vs Vds



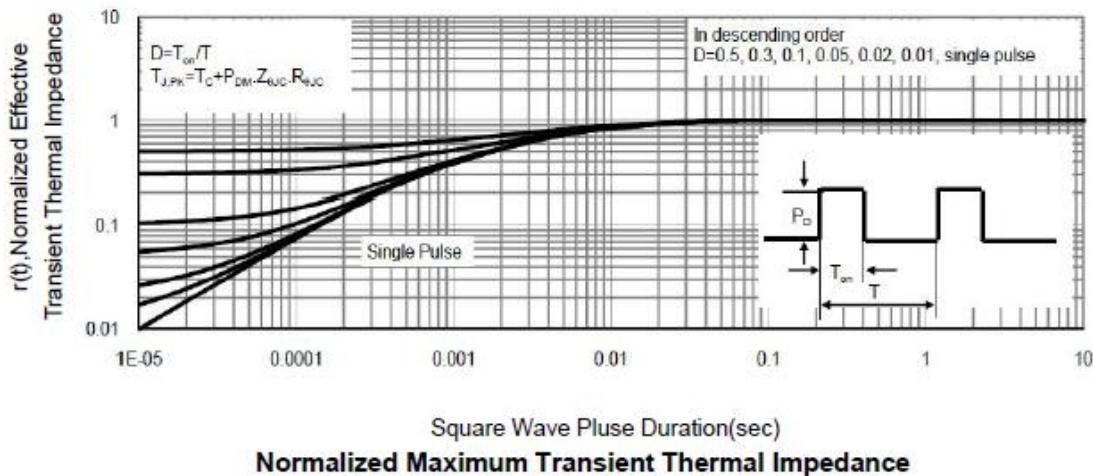
Power De-rating



Safe Operation Area

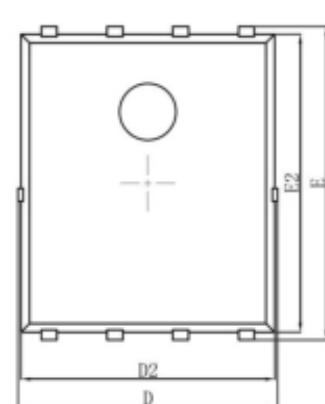


ID Current- Junction Temperature

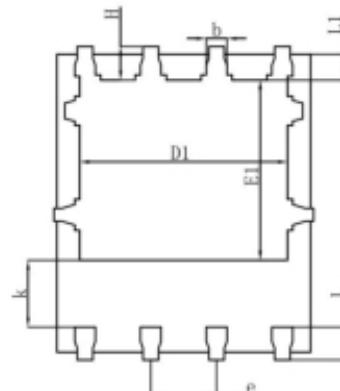


Normalized Maximum Transient Thermal Impedance

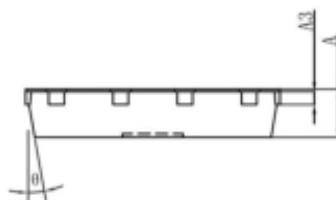
PDFNWB5X6-8L Package Information



Top View
[顶视图]



Bottom View
[底视图]



Side View
[侧视图]

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.000	0.035	0.039
A3	0.254REF.		0.010REF.	
D	4.944	5.096	0.195	0.201
E	5.974	6.126	0.235	0.241
D1	3.910	4.110	0.154	0.162
E1	3.375	3.575	0.133	0.141
D2	4.824	4.976	0.190	0.196
E2	5.674	5.826	0.223	0.229
k	1.190	1.390	0.047	0.055
b	0.350	0.450	0.014	0.018
e	1.270TYP.		0.050TYP.	
L	0.559	0.711	0.022	0.028
L1	0.424	0.576	0.017	0.023
H	0.574	0.726	0.023	0.029
θ	10°		12°	